

dsPIC33CK64MP105 Motor Control Plug-In Module (PIM) Information Sheet for External Op Amp Configuration

The dsPIC33CK64MP105 Motor Control PIM for External Op Amp Configuration (P/N: MA330050-1) is designed to demonstrate the motor control capabilities of the dsPIC33CK64MP105 device using external on-board op amps.

The dsPIC33CK64MP105 device is a high-performance, 16-bit Digital Signal Controller (DSC). This Motor Control PIM is designed to take advantage of the high-resolution PWM (with fine edge placement) peripheral on the device. The PWM, along with other peripherals, such as the ADC, enable motor control applications.

The PIM can be used to demonstrate and develop motor control applications by inserting it in the 100-pin PIM interface header provided on the compatible motor control development boards (see [Table 1](#)). The PIM is designed to run a single motor with all the compatible development boards. When operating this PIM on the dsPICDEM™ MCLV-2 Development Board, insert an external op amp configuration matrix board (see [Figure 2](#)) on the J14 header provided on the board. In the case of dsPICDEM MCHV-2/MCHV-3 Development Boards, insert an external op amp configuration matrix board on to the J4 header (as shown in [Figure 2](#)) on the board. This PIM can be used on the dsPICDEM MCHV-3 Development Board to implement and demonstrate single-stage boost Power Factor Correction (PFC) control, along with field-oriented control. The PIM design also enables stepper motor control using the dsPICDEM MCSM Development Board (DV330022).

For additional information regarding development boards, refer to the respective user's guides available on the Microchip website (www.microchip.com).

FIGURE 1: dsPIC33CK64MP105 MOTOR CONTROL PIM FOR EXTERNAL OP AMP (P/N: MA330050-1)



[Table 1](#) provides information on the hardware versions of the motor control boards that are compatible with this PIM. Refer to the specific motor control board user's guide for the hardware version identification information.

FIGURE 2: EXTERNAL OP AMP CONFIGURATION BOARD



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TABLE 1: HARDWARE COMPATIBILITY

Development Board	Part Number	Compatible Hardware Version(s)
dsPICDEM™ MCHV Development Board	DM330023	Not Compatible
dsPICDEM MCLV Development Board	DM330021	Not Compatible
Low-Voltage Motor Control Development Bundle	DV330100	Not Compatible
dsPICDEM MCLV-2 Development Board	DM330021-2	All Revisions
dsPICDEM MCHV-2 Development Board	DM330023-2	All Revisions
dsPICDEM MCHV-3 Development Board	DM330023-3	All Revisions
dsPICDEM MCSM Development Board	DM330022	All Revisions

WARNING

Do not connect non-isolated oscilloscope probes to the test points on the PIM while in use with the dsPICDEM™ MCHV-2 or MCHV-3 Development Board. Failure to heed this warning could result in hardware damage.

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Table 2 provides mapping between the 48-pin device and the 100-pin PIM.

TABLE 2: DEVICE TO PIM MAPPING (SORTED BY DEVICE PIN NUMBER)

Device Pin #	PIM Pin #	dsPIC33CK64MP105 Device Functional Description	Remarks
1	PIM:94	RP46/PWM1H/RB14	Direct Connection
2	PIM:93	RP47/PWM1L/RB15	Direct Connection
3	PIM:60	RP60/RC12	Direct Connection
4	PIM:01	RP61/RC13	Direct Connection
5	PIM:13	MCLR	Direct Connection
6	PIM:78	ANN2/RP77/RD13	Direct Connection
7	PIM:35	AN12/ANN0/RP48/RC0	Direct Connection
8	PIM:25 ⁽¹⁾	OA1OUT/AN0/CMP1A/IBIAS0/RA0	Connected via 0 Ohm Resistor
9	PIM:24 ⁽¹⁾	OA1IN-/ANA1/RA1	Connected via 0 Ohm Resistor
10	PIM:23 ⁽¹⁾	OA1IN+/AN9/RA2	Connected via 0 Ohm Resistor
11	PIM:20 ⁽¹⁾	DACOUT/AN3/CMP1C/RA3	Connected via 0 Ohm Resistor
12	PIM:21 ⁽¹⁾	OA3OUT/AN4/CMP3B/IBIAS3/RA4	Connected via 0 Ohm Resistor
13	PIM:30	AVDD	Analog Power (AVDD)
14	PIM:31 ⁽⁴⁾	AVSS	Analog Ground (AGND)
15	—	OA3IN-/AN13/CMP1B/ISRC0/RP49/RC1	Not Connected
16	—	OA3IN+/AN14/CMP2B/ISRC1/RP50/RC2	Not Connected
17	PIM:19	AN17/ANN1/IBIAS1/RP54/RC6	Direct Connection
18	PIM:02, 16, 37, 46, 62, 86 ⁽²⁾	VDD	Digital Power (DVDD)
19	PIM:15, 36, 45, 65, 75 ⁽³⁾	VSS	Digital Ground (DGND)
20	PIM:22	AN15/CMP2A/IBIAS2/RP51/RC3	Direct Connection
21	PIM:63	OSCI/CLKI/AN5/RP32/RB0	Direct Connection
22	PIM:64	OSCO/CLKO/AN6/RP33/RB1	Direct Connection
23	PIM:21	AN18/CMP3C/ISRC3/RP74/RD10	Direct Connection
24	PIM:70	AN16/ISRC2/RP55/RC7	Direct Connection
25	PIM:22 ⁽¹⁾	OA2OUT/AN1/AN7/ANA0/CMP1D/CMP2D/CMP3D/RP34/INT0/RB2	Connected via 0 Ohm Resistor
26	—	PGD2/OA2IN-/AN8/RP35/RB3	Not Connected
27	—	PGC2/OA2IN+/RP36/RB4	Not Connected
28	PIM:49	RP56/ASDA1/SCK2/RC8	Direct Connection
29	PIM:68	RP57/ASCL1/SDI2/RC9	Direct Connection
30	PIM:18	RP72/SDO2/PCI19/RD8	Direct Connection
31	PIM:15, 36, 45, 65, 75 ⁽³⁾	VSS	Digital Ground (DGND)
32	PIM:02, 16, 37, 46, 62, 86 ⁽²⁾	VDD	Digital Power (DVDD)
33	PIM:27	PGD3/RP37/SDA2/RB5	Direct Connection
34	PIM:26	PGC3/RP38/SCL2/RB6	Direct Connection
35	PIM:32	TDO/AN2/CMP3A/RP39/RB7	Direct Connection
36	PIM:61	PGD1/AN10/RP40/SCL1/RB8	Direct Connection

Note 1: The PIM pin is directly connected to the device pin through a 0 Ohm resistor (default), which can be removed if desired.

2: Digital Power (DVDD) pins are shorted together on the PIM.

3: Digital Ground (DGND) pins are shorted together on the PIM.

4: Analog Ground (AGND) connection via PIM:31 is shorted with Digital Ground (DGND) through 0 Ohm resistor, R28, on the PIM.

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TABLE 2: DEVICE TO PIM MAPPING (SORTED BY DEVICE PIN NUMBER) (CONTINUED)

Device Pin #	PIM Pin #	dsPIC33CK64MP105 Device Functional Description	Remarks
37	PIM:80	PGC1/AN11/RP41/SDA1/RB9	Direct Connection
38	PIM:84	RP52/ASDA2/RC4	Direct Connection
39	PIM:47	RP53/ASCL2/RC5	Direct Connection
40	PIM:48	RP58/RC10	Direct Connection
41	PIM:79	RP59/RC11	Direct Connection
	PIM:83		
42	PIM:15, 36, 45, 65, 75 ⁽³⁾	Vss	Digital Ground (DGND)
43	PIM:02, 16, 37, 46, 62, 86 ⁽²⁾	VDD	Digital Power (DVDD)
44	PIM:50	RP65/PWM4H/RD1	Direct Connection
45	PIM:03	TMS/RP42/PWM3H/RB10	Direct Connection
46	PIM:100	TCK/RP43/PWM3L/RB11	Direct Connection
47	PIM:99	TDI/RP44/PWM2H/RB12	Direct Connection
48	PIM:98	RP45/PWM2L/RB13	Direct Connection

- Note 1:** The PIM pin is directly connected to the device pin through a 0 Ohm resistor (default), which can be removed if desired.
- 2:** Digital Power (DVDD) pins are shorted together on the PIM.
- 3:** Digital Ground (DGND) pins are shorted together on the PIM.
- 4:** Analog Ground (AGND) connection via PIM:31 is shorted with Digital Ground (DGND) through 0 Ohm resistor, R28, on the PIM.

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Table 3 provides mapping between the 100-pin PIM and the 48-pin device.

TABLE 3: DEVICE TO PIM MAPPING (SORTED BY PIM PIN NUMBER)

PIM Pin #	Device Pin #	dsPIC33CK64MP105 Device Functional Description	Remarks
PIM:01	4	RP61/RC13	Direct Connection
PIM:02, 16, 37, 46, 62, 86 ⁽²⁾	18, 32, 43	VDD	Digital Power (DVDD)
PIM:03	45	TMS/RP42/PWM3H/RB10	Direct Connection
PIM:04	—	—	Not Connected
PIM:05	—	—	Not Connected
PIM:06	—	—	Not Connected
PIM:07	—	—	Not Connected
PIM:08	—	—	Not Connected
PIM:09	—	—	Not Connected
PIM:10	—	—	Not Connected
PIM:11	—	—	Not Connected
PIM:12	—	—	Not Connected
PIM:13	5	MCLR	Direct Connection
PIM:14	—	—	Not Connected
PIM:15, 36, 45, 65, 75 ⁽³⁾	19, 31, 42	VSS	Digital Ground (DGND)
PIM:02, 16, 37, 46, 62, 86 ⁽²⁾	18, 32, 43	VDD	Digital Power (DVDD)
PIM:17	—	—	Not Connected
PIM:18	30	RP72/SDO2/PCI19/RD8	Direct Connection
PIM:19	17	AN17/ANN1/IBIAS1/RP54/RC6	Direct Connection
PIM:20 ⁽¹⁾	11	DACOUT/AN3/CMP1C/RA3	Connected via 0 Ohm Resistor
PIM:21 ⁽¹⁾	23	AN18/CMP3C/ISRC3/RP74/RD10	Direct Connection
	12	OA3OUT/AN4/CMP3B/IBIAS3/RA4	Connected via 0 Ohm Resistor
PIM:22 ⁽¹⁾	20	AN15/CMP2A/IBIAS2/RP51/RC3	Direct Connection
	25	OA2OUT/AN1/AN7/ANA0/CMP1D/CMP2D/CMP3D/RP34/INT0/RB2	Connected via 0 Ohm Resistor
PIM:23 ⁽¹⁾	10	OA1IN+/AN9/RA2	Connected via 0 Ohm Resistor
PIM:24 ⁽¹⁾	9	OA1IN-/ANA1/RA1	Connected via 0 Ohm Resistor
PIM:25 ⁽¹⁾	8	OA1OUT/AN0/CMP1A/IBIAS0/RA0	Connected via 0 Ohm Resistor
PIM:26	34	PGC3/RP38/SCL2/RB6	Direct Connection
PIM:27	33	PGD3/RP37/SDA2/RB5	Direct Connection
PIM:28	—	VREF 1.65V	External 1.65V Reference
PIM:29	—	—	Not Connected
PIM:30	13	AVDD	Analog Power (AVDD)
PIM:31 ⁽⁴⁾	14	AVSS	Analog Ground (AGND)
PIM:32	35	TDO/AN2/CMP3A/RP39/RB7	Direct Connection
PIM:33	—	—	Not Connected
PIM:34	—	—	Not Connected
PIM:35	7	AN12/ANN0/RP48/RC0	Direct Connection

Note 1: The PIM pin is directly connected to the device pin through a 0 Ohm resistor (default), which can be removed if desired.

2: Digital Power (DVDD) pins are shorted together on the PIM.

3: Digital Ground (DGND) pins are shorted together on the PIM.

4: Analog Ground (AGND) connection via PIM:31 is shorted with Digital Ground (DGND) through 0 Ohm resistor, R28, on the PIM.

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TABLE 3: DEVICE TO PIM MAPPING (SORTED BY PIM PIN NUMBER) (CONTINUED)

PIM Pin #	Device Pin #	dsPIC33CK64MP105 Device Functional Description	Remarks
PIM:15, 36, 45, 65, 75 ⁽³⁾	19, 31, 42	Vss	Digital Ground (DGND)
PIM:02, 16, 37, 46, 62, 86 ⁽²⁾	18, 32, 43	VDD	Digital Power (DVDD)
PIM:38	—	—	Not Connected
PIM:39	—	—	Not Connected
PIM:40	—	—	Not Connected
PIM:41	—	—	Not Connected
PIM:42	—	—	Not Connected
PIM:43	—	—	Not Connected
PIM:44	—	—	Not Connected
PIM:45	—	—	Not Connected
PIM:46	—	—	Not Connected
PIM:47	39	RP53/ASCL2/RC5	Direct Connection
PIM:48	40	RP58/RC10	Direct Connection
PIM:49	28	RP56/ASDA1/SCK2/RC8	Direct Connection
PIM:50	44	RP65/PWM4H/RD1	Direct Connection
PIM:51	—	—	Not Connected
PIM:52	—	—	Not Connected
PIM:53	—	—	Not Connected
PIM:54	—	—	Not Connected
PIM:55	—	—	Not Connected
PIM:56	—	—	Not Connected
PIM:57	—	—	Not Connected
PIM:58	—	—	Not Connected
PIM:59	—	—	Not Connected
PIM:60	3	RP60/RC12	Direct Connection
PIM:61	36	PGD1/AN10/RP40/SCL1/RB8	Direct Connection
PIM:62	—	—	Not Connected
PIM:63	21	OSCI/CLKI/AN5/RP32/RB0	Direct Connection
PIM:64	22	OSCO/CLKO/AN6/RP33/RB1	Direct Connection
PIM:15, 36, 45, 65, 75 ⁽³⁾	19, 31, 42	Vss	Digital Ground (DGND)
PIM:66	—	—	Not Connected
PIM:67	—	—	Not Connected
PIM:68	29	RP57/ASCL1/SDI2/RC9	Direct Connection
PIM:69	—	—	Not Connected
PIM:70	24	AN16/ISRC2/RP55/RC7	Direct Connection
PIM:71	—	—	Not Connected
PIM:72	—	—	Not Connected
PIM:73	—	—	Not Connected
PIM:74	—	—	Not Connected
PIM:75	—	—	Not Connected
PIM:76	—	—	Not Connected

- Note 1:** The PIM pin is directly connected to the device pin through a 0 Ohm resistor (default), which can be removed if desired.
2: Digital Power (DVDD) pins are shorted together on the PIM.
3: Digital Ground (DGND) pins are shorted together on the PIM.
4: Analog Ground (AGND) connection via PIM:31 is shorted with Digital Ground (DGND) through 0 Ohm resistor, R28, on the PIM.

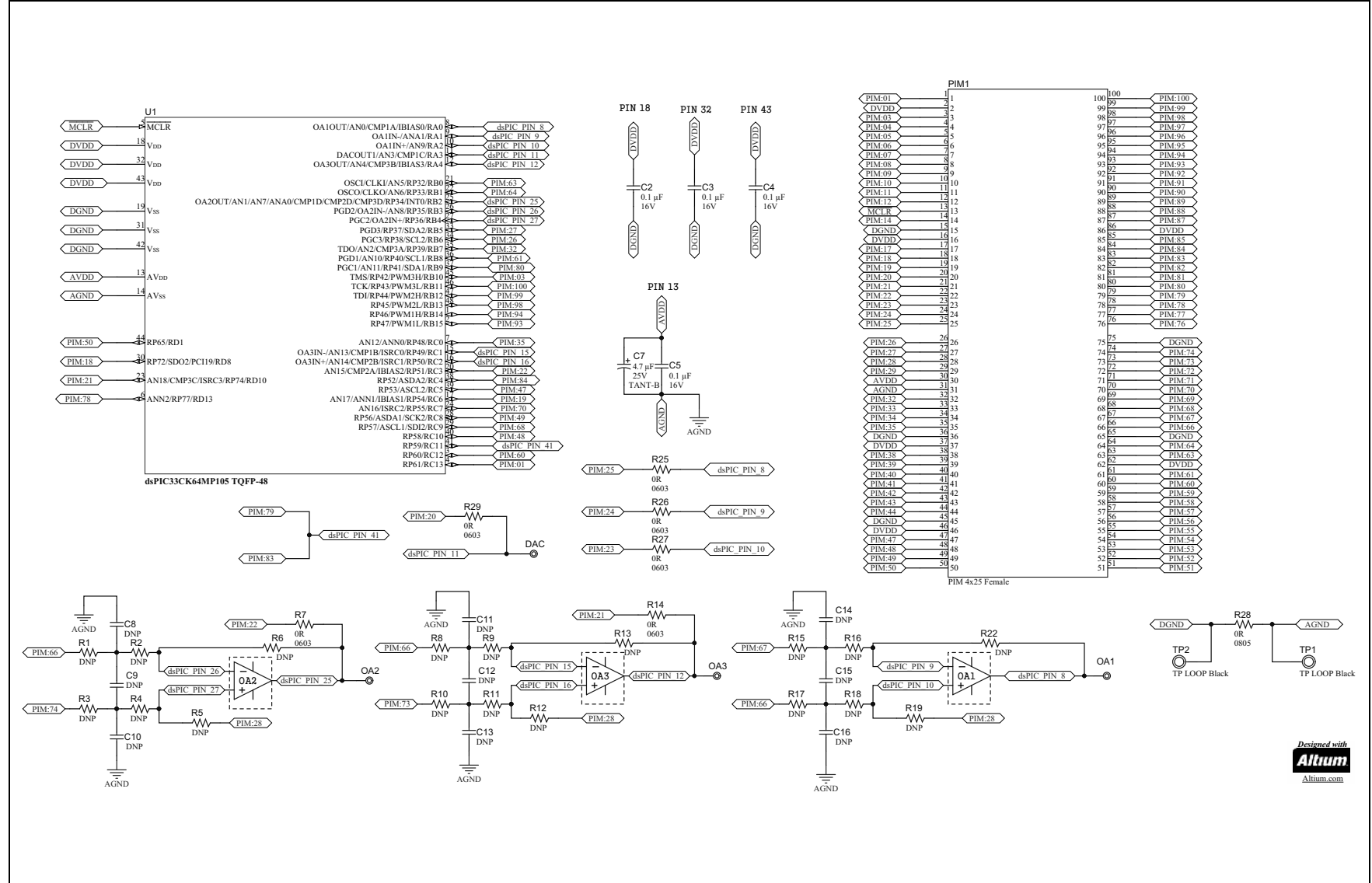
TABLE 3: DEVICE TO PIM MAPPING (SORTED BY PIM PIN NUMBER) (CONTINUED)

PIM Pin #	Device Pin #	dsPIC33CK64MP105 Device Functional Description	Remarks
PIM:77	—	—	Not Connected
PIM:78	6	ANN2/RP77/RD13	Direct Connection
PIM:79	41	RP59/RC11	Direct Connection
PIM:80	37	PGC1/AN11/RP41/SDA1/RB9	Direct Connection
PIM:81	—	—	Not Connected
PIM:82	—	—	Not Connected
PIM:83	41	RP59/RC11	Direct Connection
PIM:85	38	RP52/ASDA2/RC4	Direct Connection
PIM:86	—	—	Not Connected
PIM:87	—	—	Not Connected
PIM:88	—	—	Not Connected
PIM:89	—	—	Not Connected
PIM:90	—	—	Not Connected
PIM:91	—	—	Not Connected
PIM:92	—	—	Not Connected
PIM:93	2	RP47/PWM1L/RB15	Direct Connection
PIM:94	1	RP46/PWM1H/RB14	Direct Connection
PIM:95	—	—	Not Connected
PIM:96	—	—	Not Connected
PIM:97	—	—	Not Connected
PIM:98	48	RP45/PWM2L/RB13	Direct Connection
PIM:99	47	TDI/RP44/PWM2H/RB12	Direct Connection
PIM:100	46	TCK/RP43/PWM3L/RB11	Direct Connection

- Note 1:** The PIM pin is directly connected to the device pin through a 0 Ohm resistor (default), which can be removed if desired.
- 2:** Digital Power (DVDD) pins are shorted together on the PIM.
- 3:** Digital Ground (DGND) pins are shorted together on the PIM.
- 4:** Analog Ground (AGND) connection via PIM:31 is shorted with Digital Ground (DGND) through 0 Ohm resistor, R28, on the PIM.

dsPIC33CK64MP105 Motor Control Plug-In Module (PIM) for External Op Amp Configuration

Schematic Revision 2.0



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